Photocouplers Photorelay

## TLP3107

## 1. Applications

- Mechanical relay replacements
- Security Systems
- Measuring Instruments
- Factory Automation (FA)
- Amusement Equipment


## 2. General

The TLP3107 photorelay consists of a photo MOSFET optically coupled to an infrared light emitting diode. It is housed in a 2.54 SOP 6 package. The low ON-state resistance and the high permissible ON-state current of the the TLP3107 make it suitable for power line control applications.

## 3. Features

(1) Normally off (1-Form-A)
(2) OFF-state output terminal voltage: 60 V (min)
(3) Trigger LED current: 3 mA (max)
(4) ON-state current: 3.3 A (max) (A connection)
(5) ON -state resistance: $60 \mathrm{~m} \Omega(\max )$ (A connection)
(6) Isolation voltage: 1500 Vrms (min)
(7) Safety standards

UL under application : UL1577 File No.E67349
cUL under application : CSA Component Acceptance Service No.5A, File No.E67349

## 4. Packaging and Pin Assignment



## 5. Internal Circuit


6. Absolute Maximum Ratings (Note) (Unless otherwise specified, $\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$ )

|  | Characteristics |  | Symbol | Note | Rating | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| LED | Input forward current |  | $\mathrm{I}_{\mathrm{F}}$ |  | 30 | mA |
|  | Input forward current derating | ( $\left.\mathrm{T}_{\mathrm{a}} \geq 25^{\circ} \mathrm{C}\right)$ | $\Delta \mathrm{I}_{\mathrm{F}} / \Delta \mathrm{T}_{\mathrm{a}}$ |  | -0.3 | $\mathrm{mA} /{ }^{\circ} \mathrm{C}$ |
|  | Input forward current (pulsed) | (100 $\mu \mathrm{s}$ pulse, 100 pps ) | $\mathrm{I}_{\text {FP }}$ |  | 1 | A |
|  | Input reverse voltage |  | $\mathrm{V}_{\mathrm{R}}$ |  | 5 | V |
|  | Input power dissipation |  | $\mathrm{P}_{\mathrm{D}}$ |  | 50 | mW |
|  | Junction temperature |  | $\mathrm{T}_{\mathrm{j}}$ |  | 125 | ${ }^{\circ} \mathrm{C}$ |
| Detector | OFF-state output terminal voltage |  | $\mathrm{V}_{\text {OFF }}$ |  | 60 | V |
|  | ON-state current (A connection) |  | ION | (Note 1) | 3.3 | A |
|  | ON-state current (B connection) |  | $\mathrm{I}_{\mathrm{ON}}$ | (Note 1) | 3.3 |  |
|  | ON-state current (C connection) |  | ION | (Note 1) | 6.6 |  |
|  | ON-state current derating (A connection) | ( $\mathrm{T}_{\mathrm{a}} \geq 25^{\circ} \mathrm{C}$ ) | $\Delta \mathrm{l}_{\mathrm{ON}} / \Delta \mathrm{T}_{\mathrm{a}}$ | (Note 1) | -33 | $\mathrm{mA} /{ }^{\circ} \mathrm{C}$ |
|  | ON-state current derating (B connection) | ( $\mathrm{T}_{\mathrm{a}} \geq 25^{\circ} \mathrm{C}$ ) | $\Delta \mathrm{l}_{\mathrm{ON}} / \Delta \mathrm{T}_{\mathrm{a}}$ | (Note 1) | -33 |  |
|  | ON-state current derating (C connection) | ( $\mathrm{T}_{\mathrm{a}} \geq 25^{\circ} \mathrm{C}$ ) | $\Delta \mathrm{l}_{\mathrm{ON}} / \Delta \mathrm{T}_{\mathrm{a}}$ | (Note 1) | -66 |  |
|  | ON-state current (pulsed) | $(\mathrm{t}=100 \mathrm{~ms}$, Duty $=1 / 10)$ | IONP |  | 10 | A |
|  | Output power dissipation |  | $\mathrm{P}_{\mathrm{O}}$ |  | 430 | mW |
|  | Junction temperature |  | $\mathrm{T}_{\mathrm{j}}$ |  | 125 | ${ }^{\circ} \mathrm{C}$ |
| Common | Storage temperature |  | $\mathrm{T}_{\text {stg }}$ |  | -55 to 125 |  |
|  | Operating temperature |  | $\mathrm{T}_{\text {opr }}$ |  | -40 to 85 |  |
|  | Lead soldering temperature | (10 s) | $\mathrm{T}_{\text {sol }}$ |  | 260 |  |
|  | Isolation voltage | AC, 1 min, R.H. $\leq 60 \%$ | $\mathrm{BV}_{S}$ | (Note 2) | 1500 | Vrms |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).
Note 1: For an application circuit example, see Fig. 12.2.
Note 2: This device is considered as a two-terminal device: Pins 1,2 and 3 are shorted together, and pins 4,5 and 6 are shorted together.

## 7. Recommended Operating Conditions (Note)

| Characteristics | Symbol | Note | Min | Typ. | Max | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Supply voltage | $\mathrm{V}_{\mathrm{DD}}$ |  | - | - | 48 | V |
| Input forward current | $\mathrm{I}_{\mathrm{F}}$ |  | 5 | 10 | 25 | mA |
| ON-state current (A connection) | $\mathrm{I}_{\mathrm{ON}}$ |  | - | - | 3.3 | A |
| Operating temperature | $\mathrm{T}_{\mathrm{opr}}$ |  | -20 | - | 65 | ${ }^{\circ} \mathrm{C}$ |

Note: The recommended operating conditions are given as a design guide necessary to obtain the intended performance of the device. Each parameter is an independent value. When creating a system design using this device, the electrical characteristics specified in this datasheet should also be considered.
8. Electrical Characteristics (Unless otherwise specified, $\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$ )

|  | Characteristics | Symbol | Note | Test Condition | Min | Typ. | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| LED | Input forward voltage | $V_{F}$ |  | $\mathrm{I}_{\mathrm{F}}=10 \mathrm{~mA}$ | 1.18 | 1.33 | 1.48 | V |
|  | Input reverse current | $\mathrm{I}_{\mathrm{R}}$ |  | $\mathrm{V}_{\mathrm{R}}=5 \mathrm{~V}$ | - | - | 10 | $\mu \mathrm{A}$ |
|  | Input capacitance | $\mathrm{C}_{\mathrm{t}}$ |  | $\mathrm{V}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ | - | 70 | - | pF |
| Detector | OFF-state current | l OFF |  | $\mathrm{V}_{\text {OFF }}=60 \mathrm{~V}$ | - | - | 20 | nA |
|  | Output capacitance | $\mathrm{C}_{\text {OFF }}$ |  | $\mathrm{V}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ | - | 700 | 1500 | pF |

9. Coupled Electrical Characteristics (Unless otherwise specified, $\mathrm{Ta}_{\mathrm{a}}=25^{\circ} \mathrm{C}$ )

| Characteristics | Symbol | Note | Test Condition | Min | Typ. | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Trigger LED current | $\mathrm{I}_{\mathrm{FT}}$ |  | $\mathrm{I}_{\mathrm{ON}}=2.0 \mathrm{~A}$ | - | 0.2 | 3 | mA |
| Return LED current | $\mathrm{I}_{\mathrm{FC}}$ |  | $\mathrm{l}_{\text {OFF }}=10 \mu \mathrm{~A}$ | 0.1 | - | - |  |
| ON-state resistance (A connection) | $\mathrm{R}_{\mathrm{ON}}$ | (Note 1) | $\mathrm{l}_{\mathrm{ON}}=2.0 \mathrm{~A}, \mathrm{I}_{\mathrm{F}}=5 \mathrm{~mA}, \mathrm{t}<1 \mathrm{~s}$ | - | 30 | 60 | $\mathrm{m} \Omega$ |
| ON-state resistance (B connection) |  |  |  | - | 15 | - |  |
| ON-state resistance (C connection) |  |  | $\mathrm{I}_{\mathrm{ON}}=4.0 \mathrm{~A}, \mathrm{I}_{\mathrm{F}}=5 \mathrm{~mA}, \mathrm{t}<1 \mathrm{~s}$ | - | 8 | - |  |

Note 1: For an application circuit example, see Fig. 12.2.
10. Isolation Characteristics (Unless otherwise specified, $\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$ )

| Characteristics | Symbol | Note | Test Condition | Min | Typ. | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Total capacitance (input to output) | $\mathrm{C}_{S}$ | (Note 1) | $\mathrm{V}_{\mathrm{S}}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ | - | 0.8 | - | pF |
| Isolation resistance | $\mathrm{R}_{\mathrm{S}}$ | (Note 1) | $\mathrm{V}_{\mathrm{S}}=500 \mathrm{~V}, \mathrm{R} . \mathrm{H} . \leq 60 \%$ | $5 \times 1010$ | 1014 | - | $\Omega$ |
| Isolation voltage | $B V_{S}$ | (Note 1) | $\mathrm{AC}, 1 \mathrm{~min}$ | 1500 | - | - | Vrms |
|  |  |  | AC, 1 s in oil | - | 3000 | - |  |
|  |  |  | DC, 1 min , in oil | - | 3000 | - | Vdc |

Note 1: This device is considered as a two-terminal device: Pins 1,2 and 3 are shorted together, and pins 4,5 and 6 are shorted together.
11. Switching Characteristics (Unless otherwise specified, $\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$ )

| Characteristics | Symbol | Note | Test Condition | Min | Typ. | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Turn-on time | $\mathrm{t}_{\mathrm{ON}}$ |  | See Fig. 11.1. $\mathrm{R}_{\mathrm{L}}=200 \Omega, \mathrm{~V}_{\mathrm{DD}}=20 \mathrm{~V}, \mathrm{I}_{\mathrm{F}}=5 \mathrm{~mA}$ | - | 0.6 | 5.0 | ms |
|  |  |  | See Fig. 11.1. $\mathrm{R}_{\mathrm{L}}=200 \Omega, \mathrm{~V}_{\mathrm{DD}}=20 \mathrm{~V}, \mathrm{I}_{\mathrm{F}}=10 \mathrm{~mA}$ | - | 0.3 | 3.0 |  |
| Turn-off time | toff |  | See Fig. 11.1. $\mathrm{R}_{\mathrm{L}}=200 \Omega, \mathrm{~V}_{\mathrm{DD}}=20 \mathrm{~V}, \mathrm{I}_{\mathrm{F}}=5 \mathrm{~mA}$ | - | 0.2 | 1.0 |  |
|  |  |  | See Fig. 11.1. $\mathrm{R}_{\mathrm{L}}=200 \Omega, \mathrm{~V}_{\mathrm{DD}}=20 \mathrm{~V}, \mathrm{I}_{\mathrm{F}}=10 \mathrm{~mA}$ | - | 0.2 | 1.0 |  |



Fig. 11.1 Switching Time Test Circuit

## 12. Characteristics Curves and Circuit Connections

### 12.1. Characteristics Curves (Note)



Fig. 12.1.1 $I_{F}-T_{a}$


Fig. 12.1.3 $I_{F}-V_{F}$


Fig. 12.1.5 $\mathrm{RON}_{\mathrm{O}}-\mathrm{T}_{\mathrm{a}}$


Fig. 12.1.2 $\mathrm{ION}_{\mathrm{O}}-\mathrm{T}_{\mathrm{a}}$


Fig. 12.1.4 ION $-V_{O N}$


Fig. 12.1.6 $\mathrm{I}_{\mathrm{FT}}-\mathrm{T}_{\mathrm{a}}$


Fig. 12.1.7 toN, tofF $-I_{F}$



Fig. 12.1.8 ton, toff $-T_{a}$

Fig. 12.1.9 loff $-\mathrm{T}_{\mathrm{a}}$

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.
12.2. Circuit Connections


Fig. 12.2.1 A Connection

Fig. 12.2.3 C Connection



Fig. 12.2.2 B Connection

Package Dimensions


Weight: 0.13 g (typ.)

|  | Package Name(s) |
| :--- | :--- |
| TOSHIBA: 11-7C1S |  |

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